

CMOS 14-Stage Ripple-Carry Binary Counter/Divider and Oscillator

High-Voltage Types (20-Volt Rating)

■ CD4060B consists of an oscillator section and 14 ripple-carry binary counter stages. The oscillator configuration allows design of either RC or crystal oscillator circuits. A RESET input is provided which resets the counter to the all-0's state and disables the oscillator. A high level on the RESET line accomplishes the reset function. All counter stages are master-slave flip-flops. The state of the counter is advanced one step in binary order on the negative transition of ϕI (and ϕQ). All inputs and outputs are fully buffered. Schmitt trigger action on the input-pulse line permits unlimited input-pulse rise and fall times.

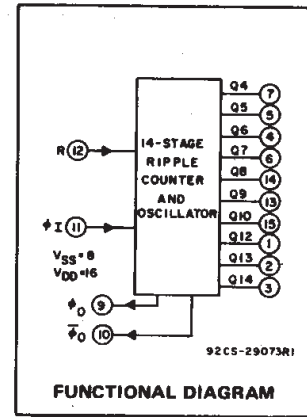
The CD4060B-series types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

Features:

- 12 MHz clock rate at 15 V
- Common reset
- Fully static operation
- Buffered inputs and outputs
- Schmitt trigger input-pulse line
- 100% tested for quiescent current at 20 V
- Standardized, symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for description of "B" Series CMOS Devices"

Oscillator Features:

- All active components on chip
- RC or crystal oscillator configuration
- RC oscillator frequency of 690 kHz min. at 15 V



Applications

- Control counters
- Timers
- Frequency dividers
- Time-delay circuits

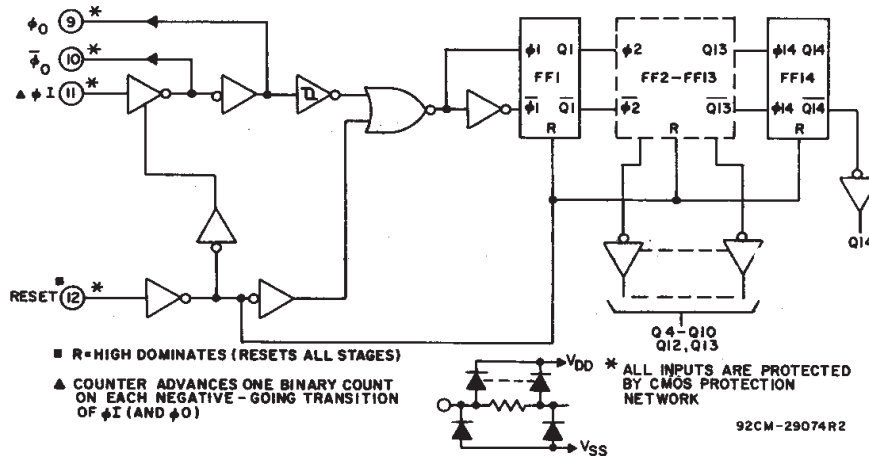


Fig. 1 - Logic diagram.

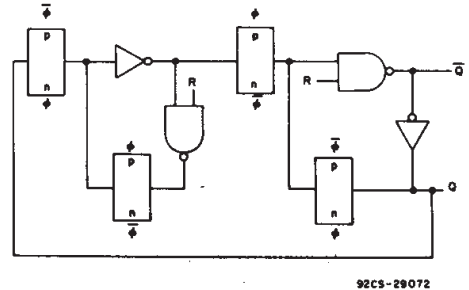


Fig. 2 - Detail of typical flip-flop stage.

MAXIMUM RATINGS, Absolute-Maximum Values:

| | |
|--|--|
| DC SUPPLY-VOLTAGE RANGE, (V_{DD}) | -0.5V to +20V |
| Voltages referenced to V_{SS} Terminal) | |
| INPUT VOLTAGE RANGE, ALL INPUTS | -0.5V to V_{DD} +0.5V |
| DC INPUT CURRENT, ANY ONE INPUT | ± 10 mA |
| POWER DISSIPATION PER PACKAGE (P_D): | |
| For $T_A = -55^\circ\text{C}$ to $+100^\circ\text{C}$ | 500mW |
| For $T_A = +100^\circ\text{C}$ to $+125^\circ\text{C}$ | Derate Linearly at 12mW/ $^\circ\text{C}$ to 200mW |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR | |
| FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Types) | 100mW |
| OPERATING-TEMPERATURE RANGE (T_A) | -55°C to $+125^\circ\text{C}$ |
| STORAGE TEMPERATURE RANGE (T_{stg}) | -65°C to $+150^\circ\text{C}$ |
| LEAD TEMPERATURE (DURING SOLDERING): | |
| At distance $1/16 \pm 1/32$ inch (1.59 ± 0.79 mm) from case for 10s max | $+265^\circ\text{C}$ |

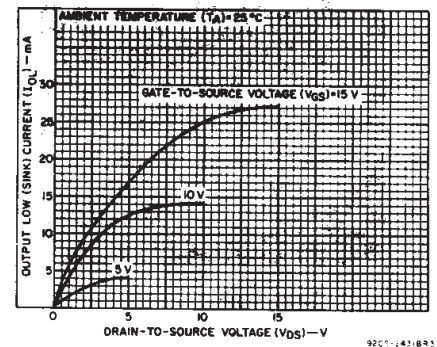


Fig. 3 - Typical n-channel output low (sink) current characteristics.

CD4060B Types

STATIC ELECTRICAL CHARACTERISTICS

| CHARACTERISTIC | CONDITIONS | | | LIMITS AT INDICATED TEMPERATURES (°C) | | | | | | | UNITS |
|---|--------------------|---------------------|---------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-------|
| | V _O (V) | V _{IN} (V) | V _{DD} (V) | -55 | -40 | +85 | +125 | +25 | | | |
| | | | | | | | | Min. | Typ. | Max. | |
| Quiescent Device Current, I _{DD} Max. | — | 0,5 | 5 | 5 | 5 | 150 | 150 | — | 0,04 | 5 | μA |
| | — | 0,10 | 10 | 10 | 10 | 300 | 300 | — | 0,04 | 10 | |
| | — | 0,15 | 15 | 20 | 20 | 600 | 600 | — | 0,04 | 20 | |
| | — | 0,20 | 20 | 100 | 100 | 3000 | 3000 | — | 0,08 | 100 | |
| Output Low (Sink) Current*, I _{OL} Min. | 0,4 | 0,5 | 5 | 0,64 | 0,61 | 0,42 | 0,36 | 0,51 | 1 | — | mA |
| | 0,5 | 0,10 | 10 | 1,6 | 1,5 | 1,1 | 0,9 | 1,3 | 2,6 | — | |
| | 1,5 | 0,15 | 15 | 4,2 | 4 | 2,8 | 2,4 | 3,4 | 6,8 | — | |
| Output High (Source) Current*, I _{OH} Min. | 4,6 | 0,5 | 5 | -0,64 | -0,61 | -0,42 | -0,36 | -0,51 | -1 | — | mA |
| | 2,5 | 0,5 | 5 | -2 | -1,8 | -1,3 | -1,15 | -1,6 | -3,2 | — | |
| | 9,5 | 0,10 | 10 | -1,6 | -1,5 | -1,1 | -0,9 | -1,3 | -2,6 | — | |
| | 13,5 | 0,15 | 15 | -4,2 | -4 | -2,8 | -2,4 | -3,4 | -6,8 | — | |
| Output Voltage: Low-Level, V _{OL} Max. | — | 0,5 | 5 | 0,05 | | | — | 0 | 0,05 | — | V |
| | — | 0,10 | 10 | 0,05 | | | — | 0 | 0,05 | — | |
| | — | 0,15 | 15 | 0,05 | | | — | 0 | 0,05 | — | |
| Output Voltage: High-Level, V _{OH} Min. | — | 0,5 | 5 | 4,95 | | | 4,95 | 5 | — | — | V |
| | — | 0,10 | 10 | 9,95 | | | 9,95 | 10 | — | — | |
| | — | 0,15 | 15 | 14,95 | | | 14,95 | 15 | — | — | |
| Input Low Voltage V _{IL} Max. | 0,5,4,5 | — | 5 | 1,5 | | | — | — | 1,5 | — | V |
| | 1,9 | — | 10 | 3 | | | — | — | 3 | — | |
| | 1,5,13,5 | — | 15 | 4 | | | — | — | 4 | — | |
| Input High Voltage, V _{IH} Min. | 0,5,4,5 | — | 5 | 3,5 | | | 3,5 | — | — | — | V |
| | 1,9 | — | 10 | 7 | | | 7 | — | — | — | |
| | 1,5,13,5 | — | 15 | 11 | | | 11 | — | — | — | |
| Input Current I _{IN} Max. | — | 0,18 | 18 | ±0,1 | ±0,1 | ±1 | ±1 | — | ±10 ⁻⁵ | ±0,1 | μA |

* Data not applicable to terminal 9 or 10.

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges

| CHARACTERISTIC | V _{DD} | LIMITS | | UNITS |
|--|-----------------|-----------|------|-------|
| | | MIN. | MAX. | |
| Supply-Voltage Range (For T _A = Full Package Temperature Range) | — | 3 | 18 | V |
| Input-Pulse Width, t _W (f = 100 kHz) | 5 | 100 | — | ns |
| | 10 | 40 | — | |
| | 15 | 30 | — | |
| Input-Pulse Rise Time and Fall Time, t _{rφ} , t _{fφ} | 5 | Unlimited | | |
| | 10 | Unlimited | | |
| | 15 | Unlimited | | |
| Input-Pulse Frequency, f _{φI} (External pulse source) | 5 | — | 3,5 | MHz |
| | 10 | — | 8 | |
| | 15 | — | 12 | |
| Reset Pulse Width, t _W | 5 | 120 | — | ns |
| | 10 | 60 | — | |
| | 15 | 40 | — | |

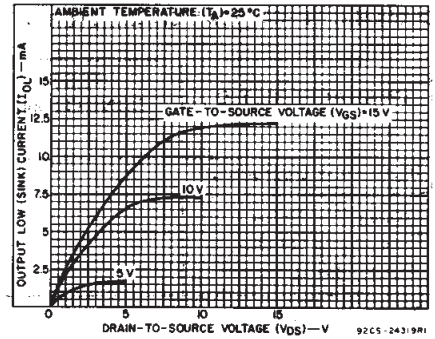


Fig. 4 - Minimum n-channel output low (sink) current characteristics.

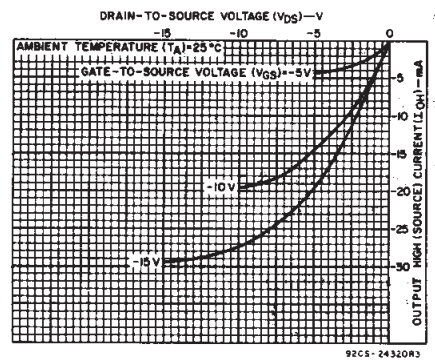


Fig. 5 - Typical p-channel output high (source) current characteristics.

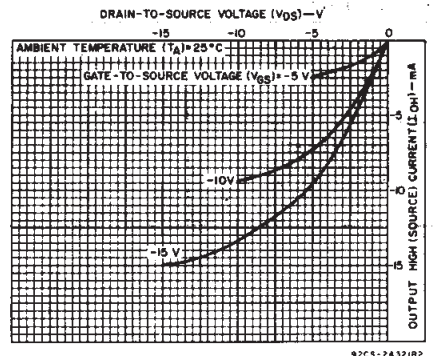


Fig. 6 - Minimum p-channel output high (source) current characteristics.

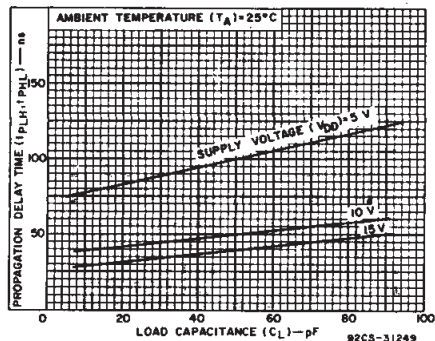


Fig. 7 - Typical propagation delay time (Q_n to Q_n+1) as a function of load capacitance.

CD4060B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$, Input $t_r, t_f = 20\text{ ns}$,
 $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

| CHARACTERISTIC | TEST CONDITIONS | LIMITS | | | UNITS | |
|--|----------------------|---------------------|-----------|------|-------|------|
| | | V _{DD} (V) | MIN. | TYP. | | MAX. |
| Input-Pulse Operation | | | | | | |
| Propagation Delay Time, ϕ_I to Q4 Out; t_{PHL}, t_{PLH} | | 5 | — | 370 | 740 | ns |
| | | 10 | — | 150 | 300 | |
| | | 15 | — | 100 | 200 | |
| Propagation Delay Time, Q_n to Q_{n+1} ; t_{PHL}, t_{PLH} | | 5 | — | 100 | 200 | |
| | | 10 | — | 50 | 100 | |
| | | 15 | — | 40 | 80 | |
| Transition Time, t_{THL}, t_{TLH} | | 5 | — | 100 | 200 | |
| | | 10 | — | 50 | 100 | |
| | | 15 | — | 40 | 80 | |
| Min. Input-Pulse Width, t_W | $f = 100\text{ kHz}$ | 5 | — | 50 | 100 | |
| | | 10 | — | 20 | 40 | |
| | | 15 | — | 15 | 30 | |
| Input-Pulse Rise & Fall Time, $t_{r\phi}, t_{f\phi}$ | | 5 | Unlimited | | | |
| | | 10 | | | | |
| | | 15 | | | | |
| Max. Input-Pulse Frequency, f_{ϕ_I} (External pulse source) | | 5 | 3.5 | 7 | — | MHz |
| | | 10 | 8 | 16 | — | |
| | | 15 | 12 | 24 | — | |
| Input Capacitance, C_I | Any Input | | — | 5 | 7.5 | pF |
| Reset Operation | | | | | | |
| Propagation Delay Time, t_{PHL} | | 5 | — | 180 | 360 | ns |
| | | 10 | — | 80 | 160 | |
| | | 15 | — | 50 | 100 | |
| Minimum Reset Pulse Width, t_W | | 5 | — | 60 | 120 | |
| | | 10 | — | 30 | 60 | |
| | | 15 | — | 20 | 40 | |

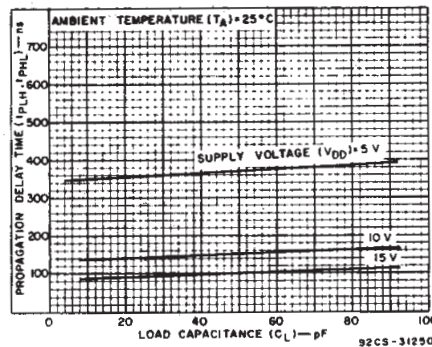


Fig. 8 - Typical propagation delay time (ϕ_I to Q₄ Output) as a function of load capacitance.

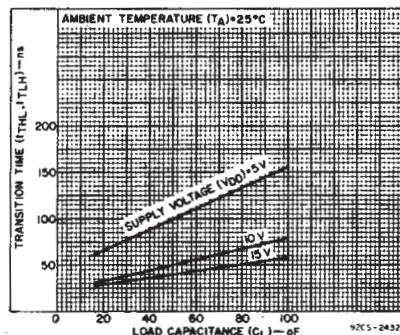


Fig. 9 - Typical transition time as a function of load capacitance.

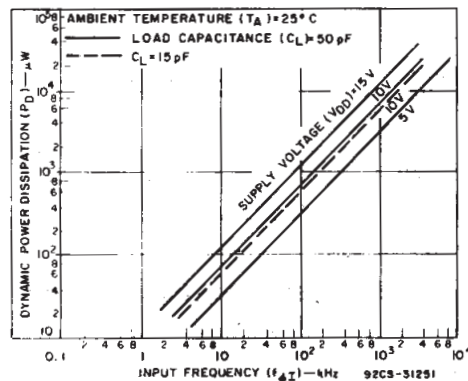


Fig. 10 - Typical dynamic power dissipation as a function of input frequency.

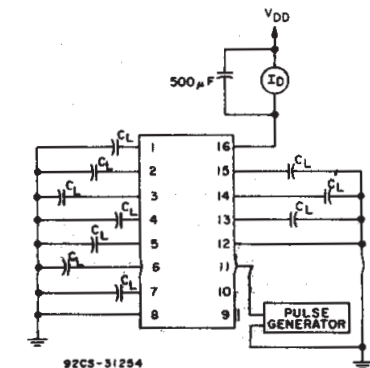


Fig. 11 - Dynamic power dissipation test circuit.

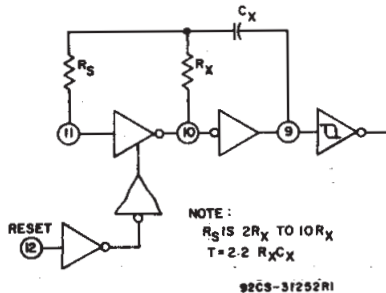


Fig. 12 - Typical RC circuit.

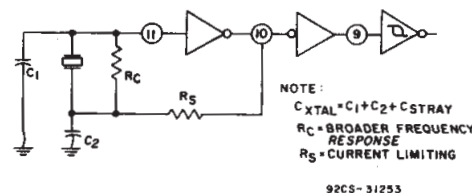


Fig. 13 - Typical crystal circuit.

CD4060B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$, Input $t_r, t_f = 20 \text{ ns}$, $C_L = 50 \text{ pF}$, $R_L = 200 \text{ k}\Omega$ [cont'd]

| CHARACTERISTIC | TEST CONDITIONS | VDD (V) | LIMITS | | | UNITS | |
|--|---|-----------------------|--------|---------------|-------|---------------|----|
| | | | Min. | Typ. | Max. | | |
| RC Operation | | | | | | | |
| Variation of Frequency (Unit-to-Unit) | $C_X = 200 \text{ pF}$, $R_S = 560 \text{ k}\Omega$, $R_X = 50 \text{ k}\Omega$ | 5 | — | $23 \pm 10\%$ | — | kHz | |
| | | 10 | — | $24 \pm 10\%$ | — | | |
| | | 15 | — | $25 \pm 10\%$ | — | | |
| Variation of Frequency with voltage change (Same Unit) | $C_X = 200 \text{ pF}$, $R_S = 560 \text{ k}\Omega$, $R_X = 50 \text{ k}\Omega$ | 5V to 10 V | — | 1.5 | — | kHz | |
| | | 10V to 15V | — | 0.5 | — | | |
| R_X max. | $C_X = 10 \mu\text{F}$ $= 50 \mu\text{F}$ $= 10 \mu\text{F}$ | 5 | — | — | 20 | M Ω | |
| | | 10 | — | — | 20 | | |
| | | 15 | — | — | 10 | | |
| C_X max. | $R_X = 500 \text{ k}\Omega$ $= 300 \text{ k}\Omega$ $= 300 \text{ k}\Omega$ | 5 | — | — | 1000 | μF | |
| | | 10 | — | — | 50 | | |
| | | 15 | — | — | 50 | | |
| Maximum Oscillator Frequency* | $R_X = 5 \text{ k}\Omega$ $R_S = 30 \text{ k}\Omega$ $C_X = 15 \text{ pF}$ | 10 | 530 | 650 | 810 | kHz | |
| | | 15 | 690 | 800 | 940 | | |
| Drive Current at Pin 9 (For Oscillator Design) | I_{OL} | $V_O = 0.4 \text{ V}$ | 5 | 0.16 | 0.35 | — | mA |
| | | $= 0.5 \text{ V}$ | 10 | 0.42 | 0.8 | — | |
| | | $= 1.5 \text{ V}$ | 15 | 1 | 2 | — | |
| | I_{OH} | $V_O = 4.6 \text{ V}$ | 5 | -0.16 | -0.35 | — | |
| | | $= 9.5 \text{ V}$ | 10 | -0.42 | -0.8 | — | |
| | | $= 13.5 \text{ V}$ | 15 | -1 | -2 | — | |

*RC oscillator applications are not recommended at supply voltages below 7 V for $R_X < 50 \text{ k}\Omega$.

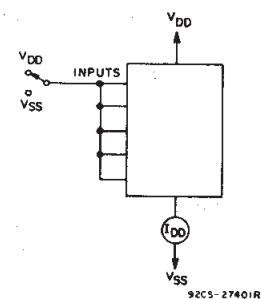


Fig. 14 – Quiescent device current.

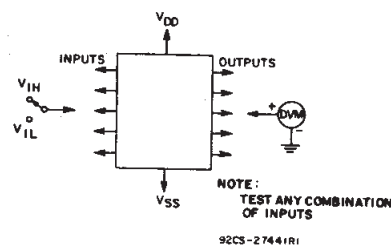


Fig. 15 – Input voltage.

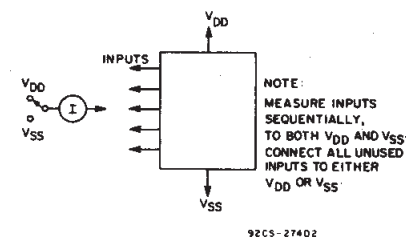
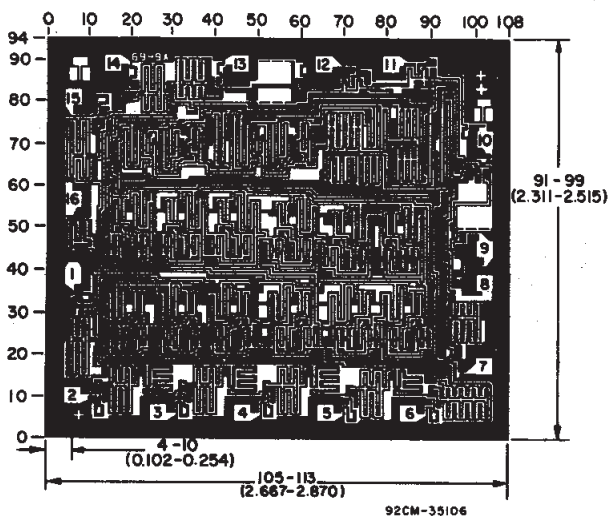
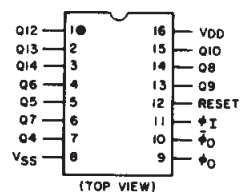


Fig. 16 – Input current.



Chip dimensions and pad layout for CD4060B

TERMINAL DIAGRAM



92CS-2376IR2

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

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